

# **BU8254GUW-E2 Datasheet**

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DiGi Electronics Part Number Manufacturer Manufacturer Product Number Description

Detailed Description

BU8254GUW-E2-DG Rohm Semiconductor BU8254GUW-E2 IC DRIVER VBGA099W060 0 Driver LVDS VBGA099W060

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# Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
BU8254GUW-E2	Rohm Semiconductor
Series:	Product Status:
-	Active
Туре:	Protocol:
Driver	LVDS
Number of Drivers/Receivers:	Duplex:
0	
Data Rate:	Voltage - Supply:
784Mbps	3V ~ 3.6V
Operating Temperature:	Mounting Type:
-20°C ~ 70°C	Surface Mount
Package / Case:	Supplier Device Package:
99-VFBGA	VBGA099W060

# **Environmental & Export classification**

RoHS Status:

**ROHS3** Compliant

**REACH Status:** 

**REACH Unaffected** 

Moisture Sensitivity Level (MSL):

3 (168 Hours)



# **Technical Note**

# LVDS Interface ICs 35bit LVDS Transmitter 35:5 Serializer



No.13057EBT10

#### Description

**BU8254GUW** 

LVDS Interface IC of ROHM "Serializer" "Deserializer" operate from 8MHz to 150MHz wide clock range, and number of bits range is from 35 to 70. Data is transmitted seven times (7X) stream and reduce cable number by 3(1/3) or less. The ROHM's LVDS has low swing mode to be able to expect further low EMI.

#### Features

- 1) 35bits data of parallel LVCMOS level inputs are converted to five channels of LVDS data stream.
- 2) 30bits of RGB data and 5bits of timing and control data(HSYNC,VSYNC,DE,CNTL1,CNTL2) are
- transmitted up to 784Mbps effective rate per LVDS channel. 3) Support clock frequency from 8MHz up to 112MHz.
- 4) Support consumer video format including 480i, 480P, 720P and 1080i as well.
- 5) Clock edge selectable
- 6) Power down mode
- 7) Support spread spectrum clock generator.
- 8) Support reduced swing LVDS for low EMI.
- 9) 30bit LVDS receiver is recommended to use BU90R104.

#### Applications

Flat Panel Display

#### Precaution

- This chip is not designed to protect from radioactivity.
- The chip is made strictly for the specific application or equipment.
- Then it is necessary that the unit is measured as need.
- This document may be used as strategic technical data which subjects to COCOM regulations.

# Block Diagram



Fig.1 Block Diagram

# ●VBGA099W060 Package Outline and Specification



number of balls : 99



# Pin configuration

	1	2	3	4	5	6	7	8	9	10
A	(NC)	TAN	TAP	TBP	TCN	TCLKN	TDN	TEN	(NC)	(NC)
В	(NC)	(NC)	TBN	LVDSVDD	ТСР	TCLKP	TDP	TEP	(NC)	(NC)
С	(1PIN)	(NC)	LVDSGND	LVDSGND	(NC)	(NC)	LVDSGND	(NC)	PLLVDD	PLLGND
D	TA5	TA1	TA0	TA2	(NC)	(NC)	TE6	(NC)	(NC)	(NC)
E	ТВ0	TA4	TA3	GND	TA6	(NC)	XRST	TE5	GND	CLK_IN
F	TB2	TB1	RS	ТВ3	(NC)	TE3	VDD	TE1	TE2	TE4
G	TB4	(NC)	GND	TB5	(NC)	(NC)	TE0	(NC)	GND	TD6
Н	(NC)	(NC)	(NC)	(NC)	TC4	(NC)	(NC)	(NC)	(NC)	TD5
J	(NC)	TB6	VDD	TC2	GND	TC6	RF	TD2	TD4	(NC)
к	(NC)	тсо	TC1	ТС3	TC5	TD0	TD1	TD3	(NC)	(NC)

# Pin Description

Table 1 : Pin Description

Pin Name	Pin No.	Туре		Descriptions				
TAP, TAN	A3,A2	LVDS OUT						
TBP, TBN	A4,B3	LVDS OUT						
TCP, TCN	B5,A5	LVDS OUT	Γ LVDS data out.					
TDP, TDN	B7,A7	LVDS OUT						
TEP, TEN	B8,A8	LVDS OUT						
TCLKP, TCLKN	B6,A6	LVDS OUT		LVDS clock out.				
TA0~TA6	D3,D2,D4,E3,E2,D1,E5	IN						
TB0~TB6	E1,F2,F1,F4,G1,G4,J2	IN						
TC0~TC6	K2,K3,J4,K4,H5,K5,J6	IN	Pixel data inputs.					
TD0~TD6	K6,K7,J8,K8,J9,H10,G10	IN						
TE0~TE6	G7,F8,F9,F6,F10,E8,D7	IN						
XRST	E7	IN	H : Normal operation, L : Power down (all outputs are Hi-Z)					
			LVDS s	wing mode, V <sub>REF</sub> <sup>*</sup>	<sup>1</sup> select.			
			RS	LVDS Swing	Small Swing Input Support			
RS	F3	IN	V <sub>DD</sub>	350mV	N/A			
			0.6~1.4V	350mV	RS-V <sub>REF</sub>			
			GND	200mV	N/A			
			*1 V <sub>REF</sub> is Input Reference Voltage.					
RF	J7	IN	Input clock triggerir H : Rising edge, L :	ng edge select. Falling edge.				
VDD	F7,J3	Power	Power supply pins	for LVCMOS input	s and digital core.			
CLKIN	E10	IN	Clock input.					
GND	E4,E9,G3,G9,J5	Ground	Ground pins for LV	CMOS inputs and	digital core.			
LVDS VDD	B4	Power	Power supply pins	for LVDS outputs.	_			
LVDS GND	C3,C4,C7	Ground	Ground pins for LV	DS outputs.				
PLLVDD	C9	Power	Power supply pin fo	or PLL core.				
PLLGND	C10	Ground	Ground pins for PLL core.					

### Electrical characteristics

### Rating

### Table 2 : Absolute Maximum Rating

Parameter	Symbol	Rat	Linite	
Falameter	Symbol	Min	Max	Units
Supply Voltage	$V_{DD}$	-0.3	4.0	V
Input Voltage	V <sub>IN</sub>	-0.3	V <sub>DD</sub> +0.3	V
Output Voltage	V <sub>OUT</sub>	-0.3	V <sub>DD</sub> +0.3	V
Storage Temperature Range	Tstg	-55	125	°C

#### Table 3 : Package Power

PACKAGE	Power Dissipation (mW)	De-rating (mW/°C) <sup>*1</sup>
	380	3.8
VBGA099W000	880 <sup>*2</sup>	8.8 <sup>*2</sup>

\*1: At temperature Ta >25°C

\*2: Package power when mounting on the PCB board.

The size of PCB board  $:70 \times 70 \times 1.6 (\text{mm}^3)$ The material of PCB board :The FR4 glass epoxy board.(3% or less copper foil area)(It is recommended to apply the above package power requirement to PCB board when the small swing input mode is used)

#### Table 4 : Recommended Operating Conditions

Doromotor	Symbol		Rating		Linita	Conditions	
Falameter	Symbol	Min	Тур	Max	Units	Conditions	
Supply Voltage	$V_{DD}$	3.0	3.3	3.6	V	VDD,LVDSVDD,PLLVDD	
Operating Temperature Pange	Topr	-20	-	85	°C	Clock frequency from 8MHz up to 90MHz	
Operating Temperature Range	торг	0	-	70	°C	Cock frequency from 90MHz up to 112MHz	

## DC characteristics

Paramotor	Symbol		Rating		Linite	Conditions	
i didilletei	Symbol	Min	Тур	Max	Units	Conditions	
High Level Input Voltage	V <sub>IH</sub>	$V_{DD} \times 0.8$	-	V <sub>DD</sub>	V	evolude RS nin	
Low Level Input Voltage	VIL	GND	-	$V_{DD} \times 0.2$	V		
High Level Input Voltage	VIHRS	$V_{DD} \times 0.8$	-	V <sub>DD</sub>		PS nin	
Low Level Input Voltage	V <sub>ILRS</sub>	GND	-	0.2			
Small Swing Voltage	$V_{DDQ}^{*1}$	1.2	-	2.8	V		
Input Reference Voltage	$V_{REF}$	-	$V_{DDQ}/2$	-	-	Small Swing(RS= $V_{DDQ}/2$ )	
Small Swing High Level Input Voltage	$V_{SH}^{*2}$	V <sub>DDQ</sub> /2 +200mV	-	-	V	V <sub>REF</sub> =V <sub>DDQ</sub> /2	
Small Swing Low Level Input Voltage	$V_{SL}^{*2}$	-	-	V <sub>DDQ</sub> /2 -200mV	V	V <sub>REF</sub> =V <sub>DDQ</sub> /2	
Input Current	I <sub>INC</sub>	-10	-	+10	μA	$0V \le V_{IN} \le V_{DD}$	

\*1: V<sub>DDQ</sub> voltage defines max voltage of small swing input. It is not an actual input voltage. \*2: Small swing signal is applied to TA[6:0], TB[6:0], TC[6:0], TD[6:0] TE[6:0], CLKIN.

Table 6 : LVDS Transmitter DC Sp	cifications( $V_{DD}$ =3.0V~3.6V, Ta=-20°C~85°C)

Parameter	Symbol		Rating		Unite	Conditions		
Falanetei	Symbol	Min	Min	Min	Units		nations	
Differential Output Veltage	V <sub>OD</sub>	250	350	450	mV	PI _100 0	Normal swing RS=V <sub>DD</sub>	
Differential Output voltage		100	200	300	mV	KL=100 32	Reduced swing RS=GND	
Change in VOD between complementary output states	$\Delta V_{OD}$	-	-	35	mV			
Common Mode Voltage	V <sub>oc</sub>	1.125	1.25	1.375	V	RL=100Ω		
Change in VOC between complementary output states	$\Delta V_{OC}$	-	-	35	mV			
Output Short Circuit Current	los	-	-	-24	mA	V <sub>OUT</sub> =0V, RI	_=100 Ω	
Output TRI-STATE Current	l <sub>oz</sub>	-10	-	+10	μA	XRST=0V, V <sub>OUT</sub> =0V to V <sub>DD</sub>		

# Supply Current

Table 7 : Supply Current

Baramatar	Symbol	Rating			Linito	Conditiona		
Falameter	Symbol	Min	Тур	Max	Units	Conditions		
Transmitter Supply	Ітсса	-	57	-	mA	RL=100 Ω ,CL=5pF V <sub>DD</sub> =3.3V,RS=V <sub>DD</sub> Gray Scale Pattern	f=85MHz	
Current		-	42	-	mA	RL=100Ω,CL=5pF V <sub>DD</sub> =3.3V,RS=GND Gray Scale Pattern	f=85MHz	
Transmitter Supply Current	I <sub>TCCW</sub>	-	62	-	mA	RL=100 $\Omega$ , CL=5pF V <sub>DD</sub> =3.3V,RS=V <sub>DD</sub> Worst Case pattern	f=85MHz	
		-	45	-	mA	RL=100 $\Omega$ ,CL=5pF V <sub>DD</sub> =3.3V,RS=GND Worst Case pattern	f=85MHz	
Transmitter Power Down Supply Current	ITCCS	-	-	10	μA	XRST=L		

# **Gray Scale Pattern**



Fig.4 Gray scale pattern

# Worst Case Pattern (Maximum Power condition)



Fig.5 Worst Case Pattern

# AC characteristics

Table 8	:	Switching	Characteristics

Parameter	Symbol	Min	Тур	Max	Units
CLK IN Transition time	t <sub>TCIT</sub>	-	-	5.0	ns
CLK IN Period	t <sub>TCP</sub>	8.93	-	125.0	ns
CLK IN High Time	t <sub>тсн</sub>	0.35t <sub>TCP</sub>	0.5t <sub>TCP</sub>	0.65t <sub>TCP</sub>	ns
CLK IN Low Time	t⊤c∟	0.35t <sub>TCP</sub>	0.5t <sub>TCP</sub>	0.65t <sub>TCP</sub>	ns
CLK IN to TCLK+/-Delay	t <sub>TCD</sub>	-	t <sub>TCP</sub>	-	ns
LVSMOS Data Set up to CLK IN	t <sub>TS</sub>	2.5	-	-	ns
LVCMOS Data Hold from CLK IN	tтн	0	-	-	ns
LVDS Transition Time	t <sub>LVT</sub>	-	0.6	1.5	ns
Output Data Position 0	t <sub>TOP1</sub>	-0.2	0.0	+0.2	ns
Output Data Position 1	t <sub>TOP0</sub>	$\frac{\text{ttcp}}{7}$ -0.2	ttcp 7	$\frac{\text{ttcp}}{7}$ +0.2	ns
Output Data Position 2	t <sub>TOP6</sub>	2 ttcp 7 -0.2	$2\frac{\text{tTCP}}{7}$	$2\frac{\text{tTCP}}{7}$ +0.2	ns
Output Data Position 3	t <sub>TOP5</sub>	3 ttcp 7 -0.2	$3\frac{\text{tTCP}}{7}$	$3\frac{\text{tTCP}}{7}$ +0.2	ns
Output Data Position 4	t <sub>TOP4</sub>	4 ttcp 7 -0.2	$4\frac{\text{ttcp}}{7}$	$4\frac{\text{tTCP}}{7}$ +0.2	ns
Output Data Position 5	t <sub>TOP3</sub>	5 ttcp 7 -0.2	$5\frac{\text{tTCP}}{7}$	$5\frac{\text{tTCP}}{7}$ +0.2	ns
Output Data Position 6	t <sub>TOP2</sub>	$6\frac{\text{ttcp}}{7}$ -0.2	$6\frac{\text{ttcp}}{7}$	$6\frac{\text{tTCP}}{7}$ +0.2	ns
Phase Locked Loop Set Time	t <sub>TPLL</sub>	-	-	10.0	ms

# AC Timing

# ■AC Timing Diagrams

LVCMOS Input





LVCMOS Input



Fig.6 AC Timing Diagrams

# Small Swing Inputs



Fig.7 Small Swing Inputs

# ■AC Timing Diagrams

LVDS Output





Fig.9 Phase Locked Loop Set Time

# System Timing Requirement

System Timing Requirement is mandatory by following two methods.

- (1) The method of using CR circuit.( In the case that CLK does not stop after power supply)
- (2) The method of using external specific IC. (In the case that CLK turns on/off after power supply)

It is recommend to do enough examination for target application.

① The method of using CR circuit.( In the case that CLK does not stop after power supply)



td is apporoximately equal to 20ms when the left RC coleus applied

#### Fig.10 The method of using CR circuit

(2) The method of using external specific IC. (In the case that CLK turns on/off after power supply)



Fig.11 The method of using external specific IC.

### 10bit LVCMOS Level Input

Example:

BU8254GUW : LVCMOS level input/Falling edge/Normal swing

BU90R104 : Falling edge



\*1: Recommended Parts: F.Bead : BLM18A-Series (Murata Manufacturing)

\*2 : If RS pin is tied to V<sub>DD</sub>, LVDS swing is 350m V. If RS pin is tied to GND, LVDS swing is 200m V.

# 10bit Small Swing Input

Example:

BU8254GUW : LVCMOS level input/Falling edge/Normal swing BU90R104 : Falling edge



\*3 : Recommended Parts:

F.Bead : BLM18A-Series (Murata Manufacturing)

\*4 : RS pin acts as VREF input pin when input voltage is set to half of high level signal input. We recommend to locate by-pass condenser near the RS pin.



Fig.12 Example for LVCMOS(1.8V input)(R1,R2)=(1.5kΩ,5.6kΩ)

### Ordering Part Number



## VBGA099W060



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(Note1	) Medical Ec	quipment	Classification	of the S	pecific Applications
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CLASSⅣ	CLASSIII	CLASSⅢ	CLASSII

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  - [f] Sealing or coating our Products with resin or other coating materials
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- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
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For details, please refer to ROHM Mounting specification

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